

Bienvenue sur O-Leading

O-Leading s'efforce d'être votre partenaire de solution unique dans la chaîne d'approvisionnement EMS, y compris la conception de circuits imprimés, la fabrication de circuits imprimés et l'assemblage de circuits imprimés (PCBA). Nous pouvons soutenir du prototype à virage rapide à la production de masse et moyenne. ([Chine multicouche fabricant de carte PCB](#))

En général, nos clients du monde entier sont très impressionnés par nos services: réponse rapide, prix compétitif et engagement de qualité. Fournir un service technique plus précieux et une solution globale est la voie à suivre pour aller de l'avant.

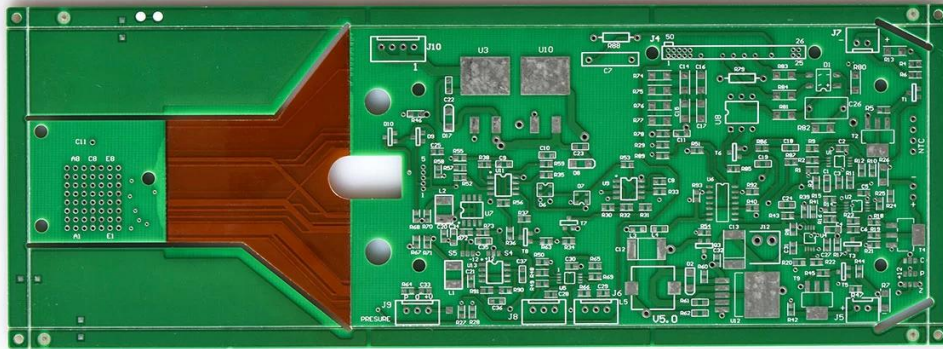
En ce qui concerne l'avenir, O-leader se concentrera sur l'innovation et le développement de la technologie de fabrication électronique, et poursuivra ses efforts en matière de guichet unique PCB & PCBA afin de fournir des services de première classe et de créer davantage de valeur pour nos clients.

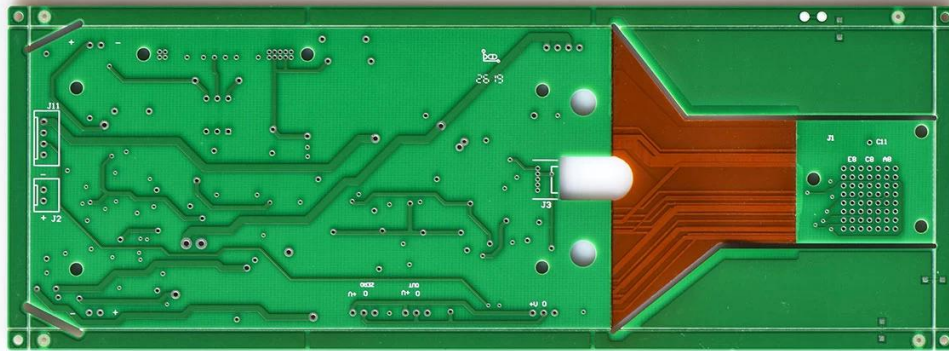
VEUILLEZ CLIQUER SUR CES INFORMATIONS POUR PLUS D'INFORMATIONS: [HDI PCB fabricant de porcelaine](#)

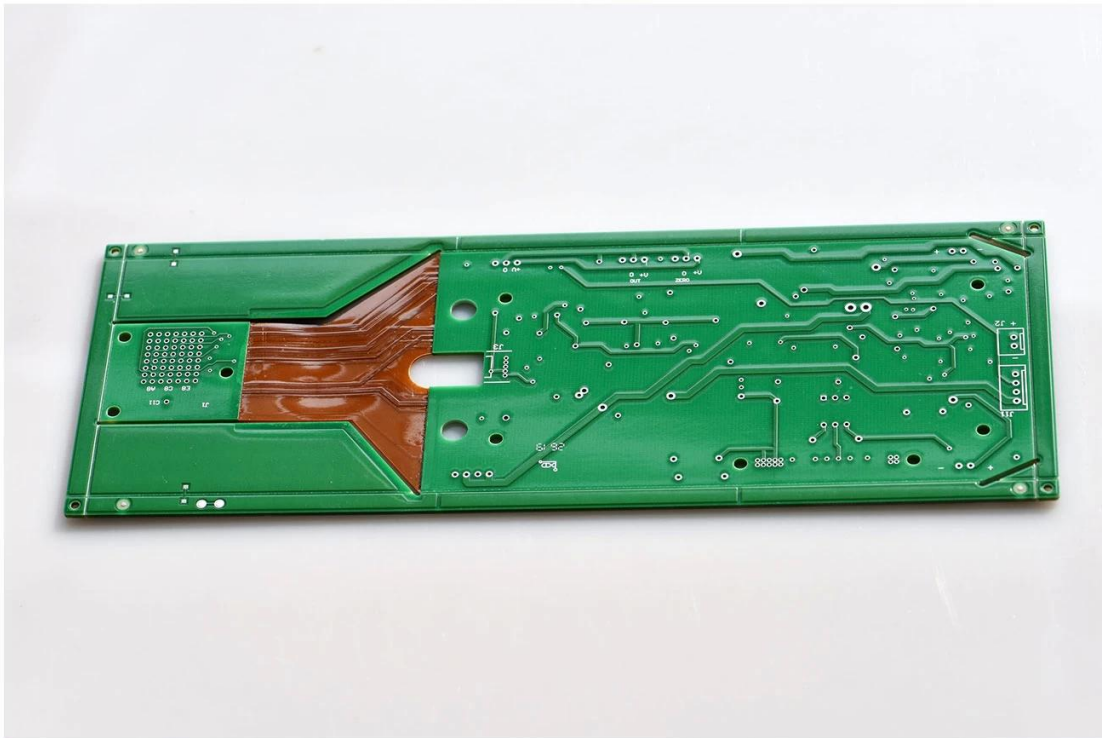
Description du produit

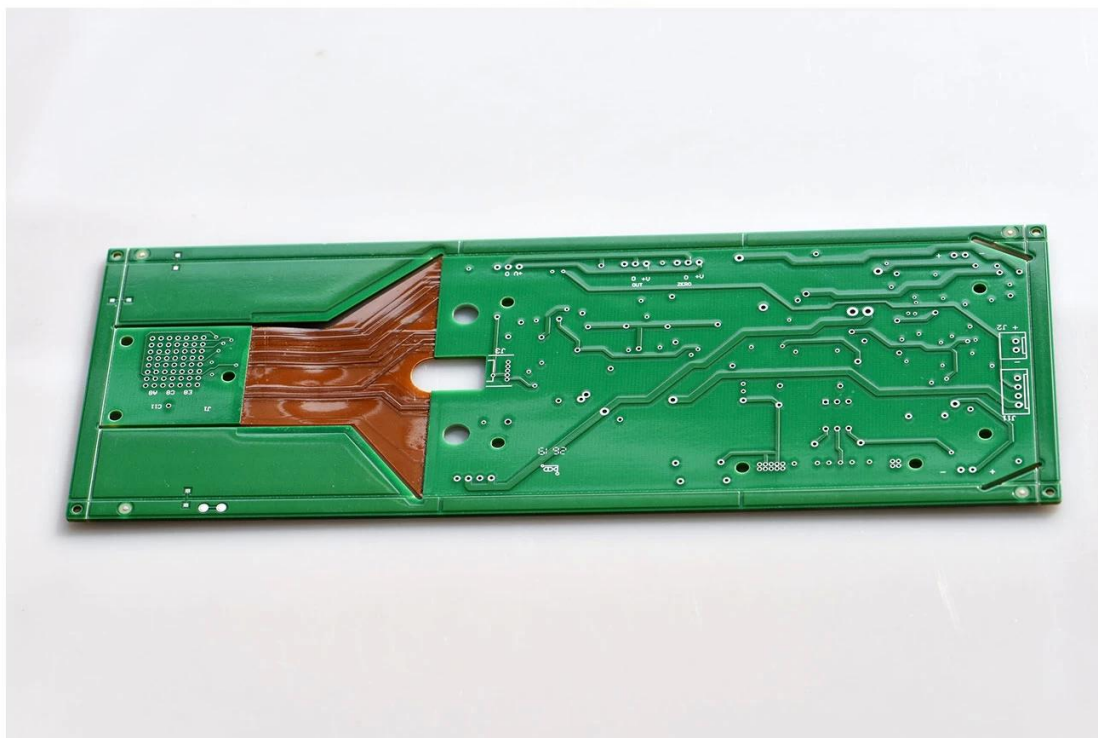
PCB P / N	RF560032Q_V5.0
Nombre de couches	4L (L1 □ L4 Rigide L2 L3 Flex)
Matériel	FR-4 TG170
Conseil thk	1.2mm
thk de cuivre	1 / H / H / 1 oz
Plus petite taille de trou	0.5MM
Nombre de trous (pcs)	285
ligne w / s	12 / 12mil
Contrôle d'impédance. O / N (Tol%)	N
Finition de surface	LF HASL Sn: 1-40UM
Sérigraphie du masque de soudure	Vert blanc
Taille unique	Dim X (mm): 220,00; Dim Y (mm): 80,00
Panérisation	Dim X (mm): 230,00; Dim Y (mm): 90,00; Non de UPS: 1
Spécial: masque pelable:	N
Routage / Poinçonnage	CNC + V-CUT

□









www.o-leading.com

Solution de contrôle à distance

Notre équipe



Factory PCB



Automatic vacuum press machine



Drilling Machine



Pattern Plating Machine



Scrubbing Machine



Developing Machine



Routing Machine



High-speed flying probe machine



E-test Machine

Factory SMT



Certifications





Test Report

No. SZXEC1900530401

Date: 30 Mar 2019

Page 1 of 6

O-LEADING SUPPLY CHAIN (HK) CO., LIMITED

1313.FLOOR 13, FORTUNE BUILDING, DANSHUI TOWN, HUIYANG DISTRICT, HUIZHOU, GUANGDONG, CHINA

The following sample(s) was/were submitted and identified on behalf of the clients as : OSP

SGS Job No. : RP19-005089 - SZ

Date of Sample Received : 22 Mar 2019

Testing Period : 22 Mar 2019 - 30 Mar 2019

Test Requested : Selected test(s) as requested by client.

Test Method : Please refer to next page(s).

Test Results : Please refer to next page(s).

Conclusion : Based on the performed tests on submitted sample(s), the results of Lead, Mercury, Cadmium, Hexavalent chromium, Polybrominated biphenyls (PBBs), Polybrominated diphenyl ethers (PBDEs) and Phthalates such as Bis(2-ethylhexyl) phthalate (DEHP) , Butyl benzyl phthalate (BBP), Dibutyl phthalate (DBP) , and Diisobutyl phthalate (DIBP) comply with the limits as set by RoHS Directive (EU) 2015/863 amending Annex II to Directive 2011/65/EU.

Signed for and on behalf of
SGS-CSTC Standards Technical Services Co., Ltd. Shenzhen Branch

Tina

Tina Fan
Approved Signatory



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中國·深圳·支那區新區中區430年工業區4樓405室 郵政編碼: 518129 電話: 755-25328888 傳真: 755-83106190 電子郵件: sgs.china@sgs.com

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Test Report

No. SZXEC1900530401

Date: 30 Mar 2019

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Test Results :

Test Part Description :

Specimen No.	SGS Sample ID	Description
SN1	SZX19-005304.001	Green"PCB"

Remarks :

- (1) 1 mg/kg = 1 ppm = 0.0001%
- (2) MDL = Method Detection Limit
- (3) ND = Not Detected (< MDL)
- (4) "-" = Not Regulated

RoHS Directive (EU) 2015/863 amending Annex II to Directive 2011/65/EU

Test Method : With reference to IEC 62321-4:2013+A1:2017, IEC 62321-5:2013, IEC 62321-7-2:2017, IEC 62321-6:2015 and IEC 62321-8:2017, analyzed by ICP-OES, UV-Vis and GC-MS.

Test item(s)	Limit	Unit	MDL	Q/Z
Cadmium (Cd)	100	mg/kg	2	ND
Lead (Pb)	1,000	mg/kg	2	8
Mercury (Hg)	1,000	mg/kg	2	ND
Hexavalent Chromium (Cr(VI))	1,000	mg/kg	8	ND
Sum of PBBs	1,000	mg/kg	-	ND
Monobromobiphenyl	-	mg/kg	5	ND
Dibromobiphenyl	-	mg/kg	5	ND
Tri bromobiphenyl	-	mg/kg	5	ND
Tetrabromobiphenyl	-	mg/kg	5	ND
Pentabromobiphenyl	-	mg/kg	5	ND
Hexabromobiphenyl	-	mg/kg	5	ND
Heptabromobiphenyl	-	mg/kg	5	ND
Octabromobiphenyl	-	mg/kg	5	ND
Nonabromobiphenyl	-	mg/kg	5	ND
Decabromobiphenyl	-	mg/kg	5	ND
Sum of PBDEs	1,000	mg/kg	-	ND
Monobromodiphenyl ether	-	mg/kg	5	ND
Dibromodiphenyl ether	-	mg/kg	5	ND
Tri bromodiphenyl ether	-	mg/kg	5	ND
Tetrabromodiphenyl ether	-	mg/kg	5	ND
Pentabromodiphenyl ether	-	mg/kg	5	ND



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ZPMV2.E490354 - WIRING, PRINTED - COMPONENT

Wiring, Printed - Component

See General Information for Wiring, Printed - Component

O-LEADING SUPPLY CHAIN (HK) CO LTD

E490354

ROOM 1205, 12/F
TAI SANG BANK BLDG
130-132 DES VOEUS ROAD
CENTRAL, HONG KONG

Type	Cond Width		Cond Thk mic(mil)	SS/ DS/ DSO	Max		Max		Meets UL796 Class	C T DSR	C I
	Min	Min			Area	Solder	Oper	Flame			
	mm(in)	mm(in)			Diam	Limits	Temp	Temp			
Multilayer (mass laminate) printed wiring boards.											
O-LEADING-401	0.1 (0.004)	0.3 (0.012)	34 (1.34)	DS	12.7 (0.5)	260	10	130	V-0	-	-
O-LEADING-407	0.08 (0.003)	0.2 (0.008)	17 (0.67)	DS	9.7 (0.4)	260	10	130	V-0	All	-
Multilayer printed wiring boards.											
O-LEADING-408	0.125 (0.005)	0.125 (0.005)	12 (0.47) Int:136	DS	50.8 (2.0)	280	20	130	V-0	All	*
Single layer printed wiring boards.											
O-LEADING-002	0.38 (0.015)	1.14 (0.045)	34 (1.34)	SS	19.1 (0.8)	260	10	105	V-0	All	-
O-LEADING-003	0.38 (0.015)	1.14 (0.045)	34 (1.34)	SS	19.1 (0.8)	260	10	130	V-0	▲	-
O-LEADING-033	0.15 (0.006)	0.3 (0.012)	34 (1.34)	SS	25.4 (1.0)	260	10	120	V-0	All	-
O-LEADING-205	0.1 (0.004)	0.3 (0.012)	34 (1.34)	DS	69.6 (2.7)	260	10	130	V-0	All	-
O-LEADING-206	0.15 (0.006)	0.33 (0.013)	17 (0.67)	DS	69.6 (2.7)	260	10	130	V-0	All	-
O-LEADING-D01	0.14 (0.006)	0.15 (0.006)	33 (1.30)	DS	25.4 (1.0)	260	10	130	V-0	All	*
O-LEADING-S01	0.25 (0.010)	0.25 (0.010)	17 (0.67)	SS	25.4 (1.0)	260	4	130	V-0	All	*

WIRING, PRINTED - COMPONENT | UL Product iQ

O-LEADING-S02	0.2 (0.008)	0.2 (0.008)	17 (0.67)	SS	25.4 (1.0)	260	4	130	HB	▲	*
O-LEADING-S03	0.25 (0.010)	0.25 (0.010)	34 (1.34)	SS	25.4 (1.0)	260	4	130	V-0	All	*

* - CTI marking is optional and may be marked on the printed wiring board.

Marking: Company name or file number and type designation. May be followed by a suffix to denote factory identification or burning test classification.

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Shipping service



Quick Turn Lead Time		
Layer Count:	Lead Tim	Special Requirement
1L/2L	2-3days	24 Hours,48 Hours
4L	3-4days	48 Hours
6L	4-5days	72 Hours
8L	5-6days	NA
10L	6-7days	NA
12L	7-8days	NA
14L	8-9days	NA

Standard Lead Time		
Layer Count:	Sample Lead Time	Volume order lead time
2L	4 days	10 days
4L	5 days	11 days
6L	6 days	12 days
8L	8 days	14 days
10L	10 days	16 days
12L	12 days	18 days
14L	14 days	20 days
16-32L	18 days	24 days

Capacité du processus

Capacités de production de PCB

Nombre de couches: 1Layer-32Layer

Épaisseur de cuivre fini: 1 / 3oz-12oz

Largeur de trait / espacement interne □ 3.0mil / 3.0mil

Largeur / espacement des lignes externe: 4.0mil / 4.0mil

Ratio d'aspect maximum: 10: 1

Épaisseur du panneau: 0.2mm-5.0mm

Taille maximale du panneau (pouces): 635 * 1500mm

Taille minimale du trou percé: 4mil

Tolérance de trou piquée: +/- 3mil

Blind / Buried Vias (types All): OUI

Via remplissage (conducteur, non conducteur): OUI

Matériau de la base: FR-4, Matériau sans halogène, FR-4high Tg., Rogers, Base en aluminium,Polyimide, Cuivre lourd

Finitions de surface: HASL, OSP, ENIG, HAL-LF, argent d'immersion,Etain d'immersion, doigts dorés, encre carbone

Capacités de production SMT

Matériel de carte: FR-4, CEM-1, CEM-3, panneau à base d'aluminium

Taille maximale du circuit imprimé: 510x460mm

Taille minimale de la carte: 50x50mm

Épaisseur du circuit imprimé: 0.5mm-4.5mm

Épaisseur du panneau: 0.5-4mm

Taille minimum des composants: 0201

Composant de taille de puce standard: 0603 et plus

Hauteur maximale du composant: 15mm

Pas de plomb: 0.3mm

Pas de balle BGA: 0.4mm

Précision de positionnement: +/- 0.03mm